

SNUBBERLESS TRIACS

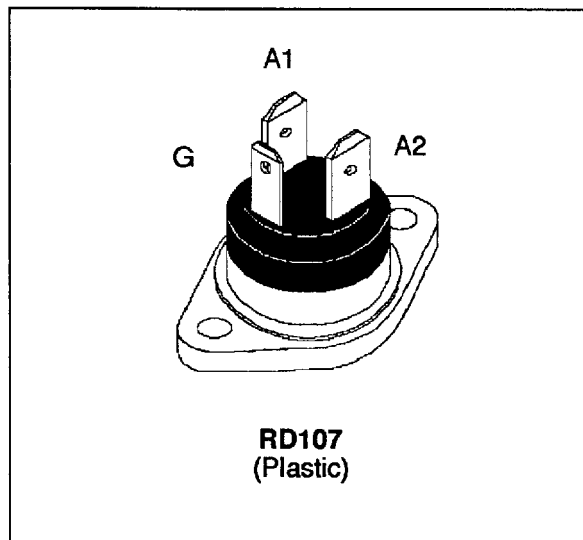
FEATURES

- $I_{T(RMS)} = 25A$
- HIGH COMMUTATION :
 $(di/dt)_c \geq 12A/ms$ T2514xKS
 $\geq 22A/ms$ T2516xKS
- INSULATING VOLTAGE = $2500V_{(RMS)}$
 (UL RECOGNIZED : E81734)

DESCRIPTION

The T2514/T2516xKS series of isolated triacs uses a high performances MESA GLASS technology.

The SNUBBERLESS™ concept offer suppression of RC network and it is suitable for application such as phase control and static switching on inductive or resistive load.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (360° conduction angle)		$T_c = 85^\circ C$ 25	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = $25^\circ C$)		$t_p = 8.3ms$ 260	A
			$t_p = 10ms$ 250	
I^2t	I^2t value for fusing		$t_p = 10ms$ 312	A^2s
di/dt	Critical rate of rise of on-state current $I_G = 500mA$ $dI_G/dt = 1A/\mu s$		Repetitive $F = 50Hz$ 20	$A/\mu s$
			Non repetitive 100	
T_{sig} T_j	Storage and operating junction temperature range		- 40 + 150 - 40 + 125	$^\circ C$
TI	Maximum lead temperature for soldering during 10s		260	$^\circ C$

Symbol	Parameter	Voltage				Unit
		D	M	S	N	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 125^\circ C$	400	600	700	800	V

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THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth(j-c)	Junction to case for D.C	1.7	°C/W
Rth(j-c)	Junction to case for A.C 360° conduction angle (F=50Hz)	1.3	°C/W

GATE CHARACTERISTICS (maximum values)

$P_G (AV) = 1 W$ $P_{GM} = 10 W$ ($t_p = 20 \mu s$) $I_{GM} = 4 A$ ($t_p = 20 \mu s$)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrant		Sensitivity		Unit
					14	16	
I_{GT}	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$	I-II-III	MIN	2		mA
				MAX	35	50	
V_{GT}	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$	I-II-III	MAX	1.5		V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3k\Omega$	$T_j = 125^\circ C$	I-II-III	MIN	0.2		V
tgt	$V_D = V_{DRM}$ $I_T = 35A$ $I_G = 500mA$ $di_G/dt = 3A/\mu s$	$T_j = 25^\circ C$	I-II-III	TYP	2		μs
I_H^*	$I_T = 250mA$ Gate open	$T_j = 25^\circ C$		MAX	35	50	mA
I_L	$I_G = 1.2 I_{GT}$	$T_j = 25^\circ C$	I-III	TYP	35	50	mA
			II	TYP	70	100	
V_{TM}^*	$I_{TM} = 35A$ $t_p = 380\mu s$	$T_j = 25^\circ C$		MAX	1.5		V
I_{DRM} I_{RRM}	$V_D = V_{DRM}$ $V_R = V_{RRM}$	$T_j = 25^\circ C$		MAX	10		μA
		$T_j = 125^\circ C$		MAX	3		mA
dV/dt^*	$V_D = 67\% V_{DRM}$ Gate open	$T_j = 125^\circ C$		MIN	500	750	V/ μs
$(di/dt)_c^*$	Without snubber	$T_j = 125^\circ C$		MIN	12	22	A/ms
				TYP	24	44	

* For either polarity of electrode A₂ voltage with reference to electrode A₁

ORDERING INFORMATION

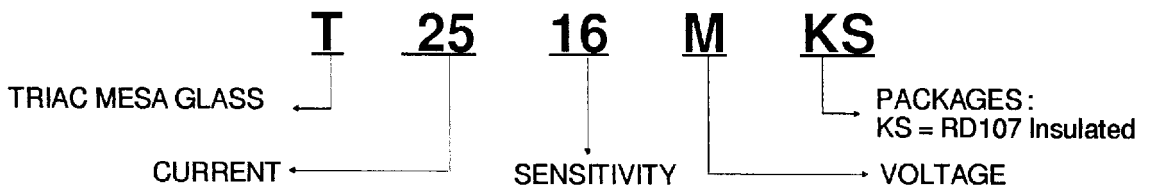


Fig.1 : Maximum RMS power dissipation versus average on-state current.

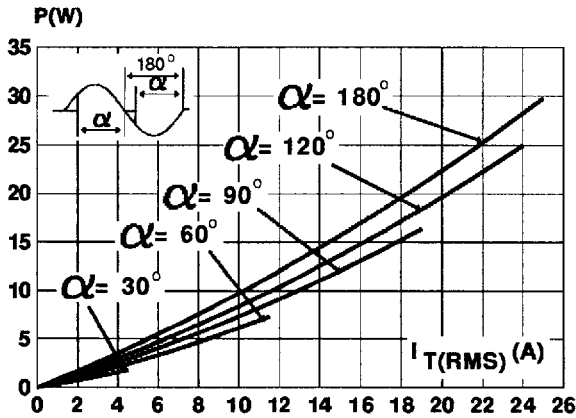


Fig.3 : RMS on-state current versus case temperature.

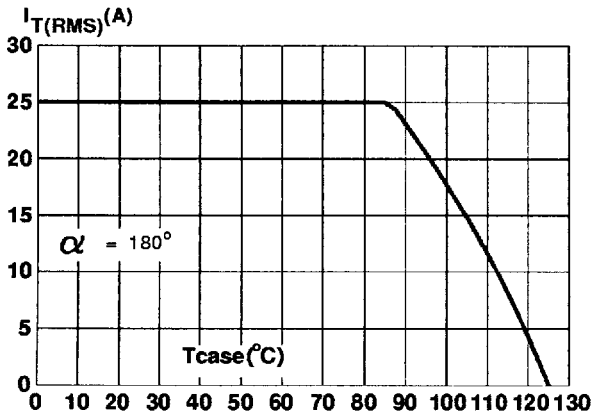


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

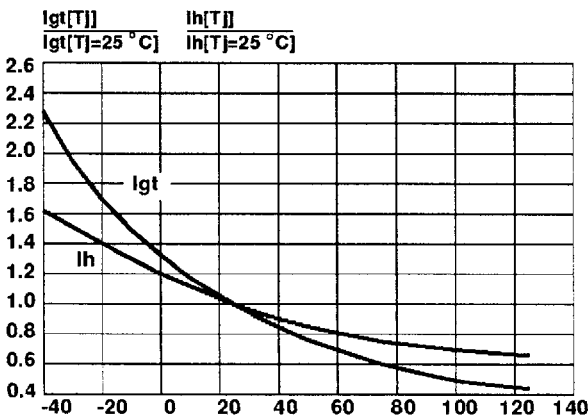


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperature (T_{amb} and T_{case}) for different thermal resistances heatsink + contact).

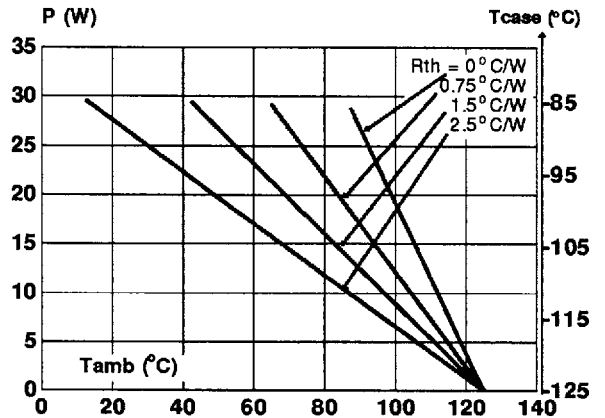


Fig.4 : Relative variation of thermal impedance junction to case versus pulse duration.

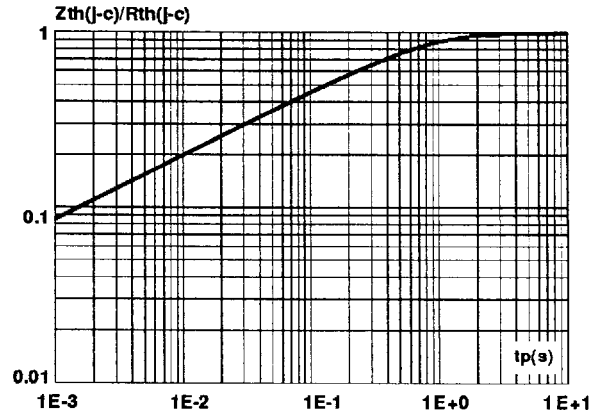
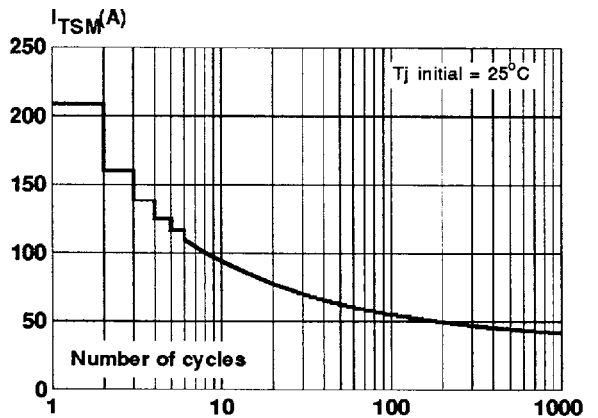


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.



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Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t_p \leq 10\text{ms}$, and corresponding value of I^2t .

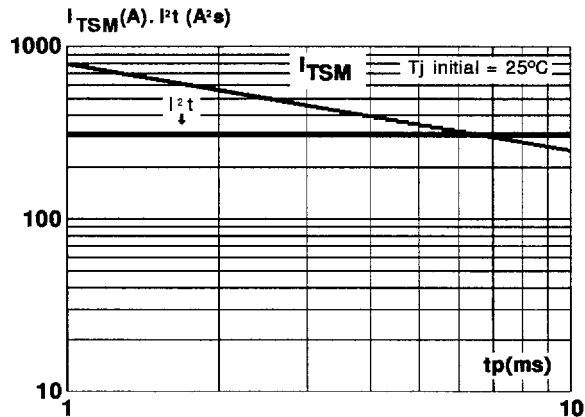
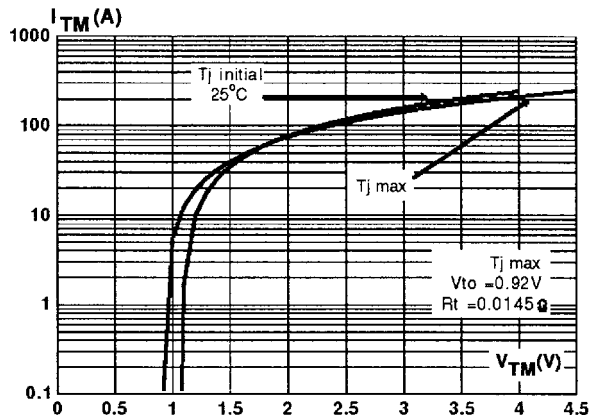
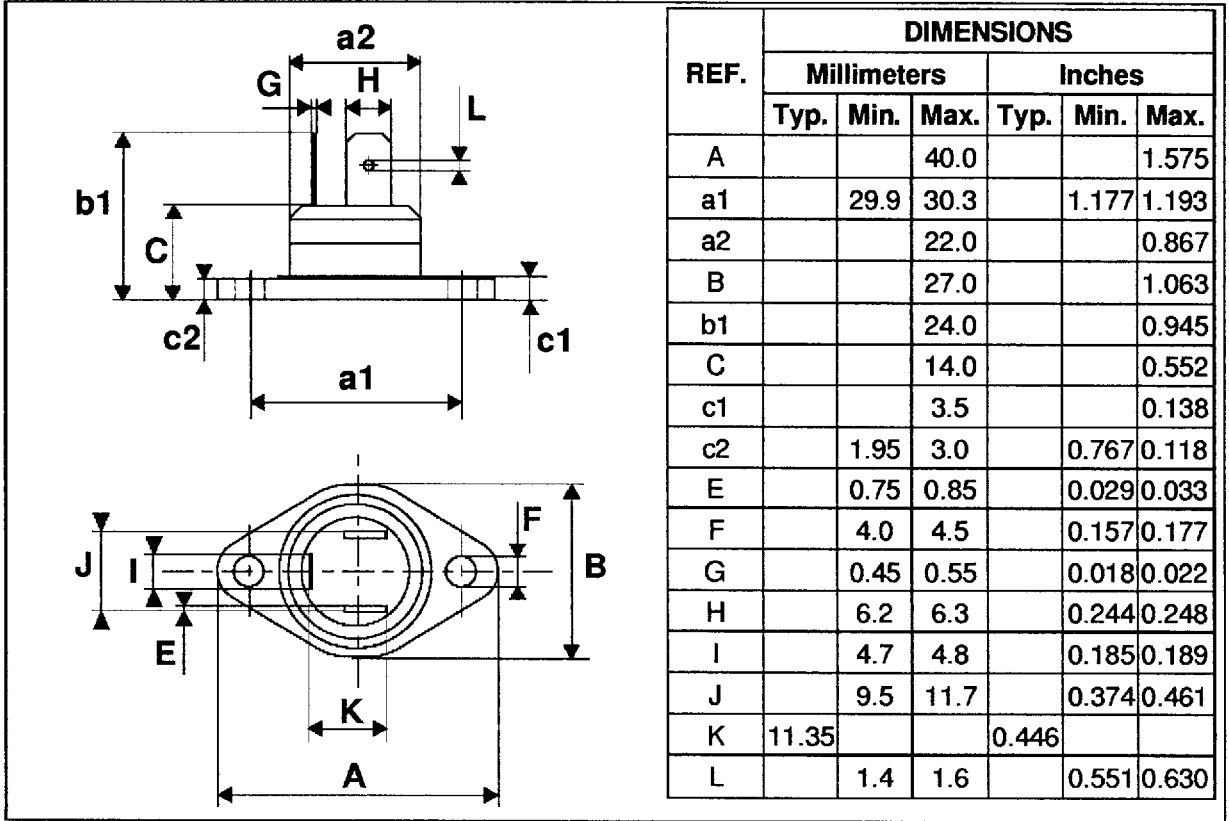


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

RD107 (Plastic)



Marking : type number

Weight : 20g

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